SCOPE:

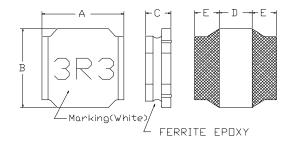
This specification applies to the Pb Free high current type SMD inductors for MNR-6020-SERIES

PRODUCT INDENTIFICATION

MNR - 6020 - 3R3 M

- (I) (2
- 3 4
- **① Product Code**
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 6.0±0.2 mm

B: 6.0±0.2 mm

C: 2.0±0.2 mm

D: 2.70Typ. mm

E: 1.65Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)
SRF: HP 4291B IMPEDANCE ANALYZER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature +60°C Max.
- (3)-2 Operate temperature range -40° C \sim +125 $^{\circ}$ C (Including self temp. rise)
- (3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE 1

MAGLAYERS	Inductance	Percent	L Test	SRF(MHz)	Resistance	Rated DC Current		Marking
PT/NO.	L(µH)	Tolerance	Frequency	Min.	RDC(Ω)±30%	IDC1(A)	IDC2(A)	Warking
MNR-6020-1R5□	1.5	N	100KHz/0.25V	93	26m	4.00	3.20	1R5
MNR-6020-2R2	2.2	N	100KHz/0.25V	73	34m	3.20	2.70	2R2
MNR-6020-3R3	3.3	M,N	100KHz/0.25V	55	40m	2.80	2.60	3R3
MNR-6020-4R7□	4.7	M,N	100KHz/0.25V	43	58m	2.40	2.00	4R7
MNR-6020-5R6□	5.6	M,N	100KHz/0.25V	37	66m	2.20	1.90	5R6
MNR-6020-6R8	6.8	M,N	100KHz/0.25V	30	85m	2.00	1.80	6R8
MNR-6020-100	10	M,N	100KHz/0.25V	18	0.125	1.70	1.40	100

※ ☐ specify the inductance tolerance,M(±20%),N(±30%)

% IDC1 : Based on inductance change (△L/Lo : drop 30% Max.) @ ambient temp. 25 $^{\circ}$ C

IDC2: Based on temperature rise ($\triangle T$: 40°C Typ.)

Rated DC Current: The less value whith is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS				
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		in figure 1 and a load applied unitil the figure in the arrow				
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)				
	no mechanical	PCB dimension shall the page 7/9				
	damage or elec-	F(Pressurization)				
	trical damege.	П				
		R5 45±2 45±2 10 20 R340				
		PRESSURE ROD figure-1				
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		and when a vibration having an amplitude of 1.52mm				
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should				
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.				
	damage.	(A total of 6 hours)				
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated				
	More than 90%	over the whole of the sample before hard, the sample shall				
		then be preheated for about 2 minutes in a temperature of				
		130~150℃ and after it has been immersed to a depth 0.5mm				
		below for 3±0.2 seconds fully in molten solder M705 with				
		a temperature of 245±5℃.				
		More than 90% of the electrode sections shall be couered				
		with new solder smoothly when the sample is taken out of				
		the solder bath.				

MECHANICAL

TEST ITEM	SPECIFICATION						
TEST ITEM Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	SPECIFICATION Temperature profile of reflow soldering soldering (Peak temperature 260±3°C 10 sec 250 Pre-heating Slow cooling (Stored at room temperature) 2 min 100 2 min or mare					
		The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.					

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS				
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top				
resistance	no other	surface and the terminal.				
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.				
	problems.					
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top				
withstand	no other	surface and the terminal of this sample				
voltage	damage or					
	problems.					
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in				
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}\!$				
		calculated based on the value applicable in a normal				
		temperature and narmal humidity shall be \triangle L/L20 $^{\circ}$ C \leq ±10%.				



ENVIROMENT CHARACTERISTICS

TEST ITEM	SPECIFICATION							
High temperature	△L/Lo≦±5% The sample shall be left for 96±4 hours in an atmospere with							
storage	△2229=2070		a temperature of 85±2°C and a normal humidity.					
Storage	There shall be	_	Upon completion of the measurement shall be made after the					
	no mechanical	sample has been left in a normal temperature and normal						
		humidity for 1 hour.						
	damage.	numunty for 1 hour.						
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with						
storage		a temper	a temperature of -25±3℃.					
	There shall be	Upon completion of the test, the measurement shall be made						
	no mechanical	after the	samp	ole has been left in a no	rmal temperature and	I		
	damage.	normal h						
Change of	∆L/Lo≦±5%	The sam	The sample shall be subject to 5 continuos cycles, such as shown					
temperature		in the tab	ole 2 l	pelow and then it shall b	e subjected to stand	ard		
	There shall be	atmosph	eric c	onditions for 1 hour, af	ter which measureme	ent		
	no other dama-	shall be i	shall be made.					
	ge of problems							
				table 2				
				Temperature	Duration			
			1	−25±3 °C	30 min.			
				(Themostat No.1)	••			
		2	Standard	No.4 - No.2				
			_	atmospheric	No.1→No.2			
			3	85±2 ℃	30 min.			
				(Themostat No.2)	55			
			4	Standard	No O. No 4	=		
			•	atmospheric	No.2→No.1			
Majotura ataraga	A 1 /1 a < +E0/	The semi	nla al	all he left for 05±4 hour	ro in a tomporature of	.		
Moisture storage	∆L/Lo≦±5%			nall be left for 96±4 hour	-			
	There about he		40±2℃ and a humidity(RH) of 90~95%.					
	There shall be	Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and						
	no mechanical							
T	damage.	normal h	umid	ity more than 1 hour.				
Test conditions:								
The s	sample shall be reflo	w soldered	onto	the printed circuit boar	d in every test.			

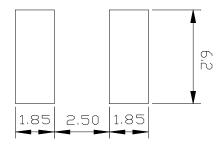


(5) LAND DIMENSION (Ref.)

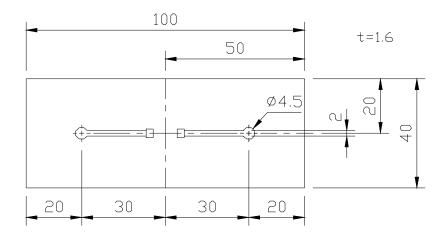
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) unit: mm



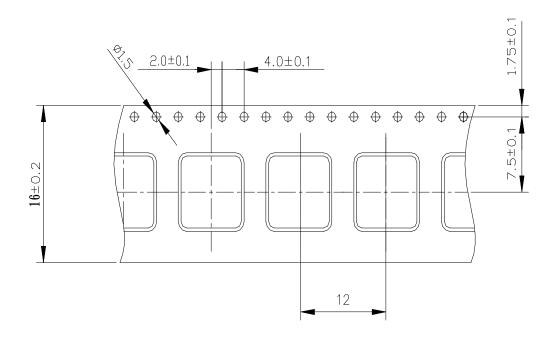
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



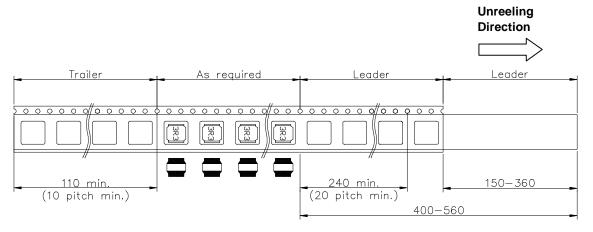


(6) PACKAGING

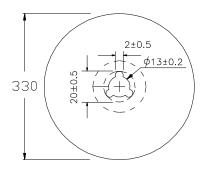
(6)-1 CARRIER TAPE DIMENSIONS (mm)

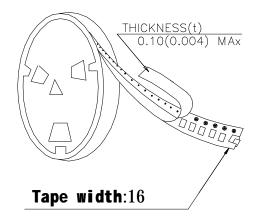


(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

2000pcs/Reel

The products are packaged so that no damage will be sustained.